Components marked 'DNP' should not be populated.

Assembly variant: Do not populate

<table>
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<th>PCB VIEWED FROM TOP SIDE</th>
<th>BOARD #: TIDA-01619</th>
<th>REV: E1</th>
<th>SVN REV: Not In VersionControl</th>
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</thead>
<tbody>
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<td>TID #: TIDA-01619</td>
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Plot Name = Top Assembly Drawing

Generated: 2/19/2018 4:13:04 PM

Texas Instruments
Components marked 'DNP' should not be populated.
Assembly Variant: Do Not Populate

<table>
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<th>PCB Viewed from Bottom Side</th>
<th>Board #: TIDA-01619</th>
<th>Rev.: E1</th>
<th>SUN Rev.: Not In VersionControl</th>
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| Plot Name = Bottom Assembly Drawing | Generated: 2/19/2018 4:13:06 PM | Texas Instruments |
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